LIST OF THE CLAIMS

(Previously presented) A wafer edge exposing apparatus, comprising:

 a light source device for generating source light having a wavelength of about 315

nm to about 400 nm;

an optical fiber cord for guiding the source light generated from the light source device into a light focusing device;

a lens positioned in the light focusing device to receive the source light from the optical fiber cord, the light focusing device to focus the source light to the edge of a wafer; and

a wavelength converter for directly converting the wavelength of the source light to a wavelength of about 193 nm which corresponds to the highest absorptivity of a photoacid generator of resist coated on the wafer.

- (Original) The wafer edge exposing apparatus of claim 1, wherein the light source device includes a lamp, a parabolic or elliptical mirror, a plate, a shutter, and a filter.
- (Original) The wafer edge exposing apparatus of claim 1, wherein the wavelength converter is made of an optically non-linear material.
- 4. (Original) The wafer edge exposing apparatus of claim 3, wherein the optically non-linear material is one selected from the group consisting of beta barium borate (β-BaB₂O₄), lithium triborate (LiB₃O₅), cesium lithium borate (CsLiB₆O₁₆), potassium titanyl phosphate (KTiOPO₄), potassium titanyl arsenate (KTiOAsO₄), potassium dihydrogen phosphate (KH₂PO₄), deuterated ammonium dihydrogen phosphate (KD₂PO₄), ammonium dihydrogen phosphate (ND₄H₂PO₄), deuterated ammonium dihydrogen phosphate (ND₄H₂PO₄), rebidium dihydrogen phosphate (RbH₂PO₄), cesium dihydrogen arsenate (CsH₂AsO₄), deuterated cesium dihydrogen

arsenate (CsH₂AsO₄), lithium niobate (LiVbO₃), lithium tantelate (LiTaO₃), lithium iodata (LiIO₃), potassium niobate (KNbO₃), barium nitrate (Ba(NO₃)₂), solid-state raman shifters (KGd(WO₄)₂), potassium pentaborate, 3-methyl-4-nitropyridine-1 oxide, L-ariginine phosphate, and combinations thereof.

- (Original) The wafer edge exposing apparatus of claim 1, wherein the resist is ArF resist.
- (Original) The wafer edge exposing apparatus of claim 2, wherein the lamp is a mercury arc lamp.
- (Original) The wafer edge exposing apparatus of claim 1, wherein the source light is i-line.
- (Original) The wafer edge exposing apparatus of claim 1, wherein the source light is one of lights having a wavelength within the ultraviolet range.
- (Original) The wafer edge exposing apparatus of claim3, wherein the wavelength converter is made of either one of potassium titanyl phosphate (KTiOPO₄) and potassium dihydrogen phosphate (KH₂PO₄).
- (Original) The wafer edge exposing apparatus of claim 2, wherein the wavelength converter is positioned in front of the lamp.
- (Original) The wafer edge exposing apparatus of claim 2, wherein the wavelength converter is positioned between the optical fiber cord and the filter.
- (Original) The wafer edge exposing apparatus of claim 1, wherein the wavelengths converter is positioned between the lens and the optical fiber cord.

- (Original) The wafer edge exposing apparatus of claim 1, wherein the wavelength converter is installed at the end of the light focusing device.
- (Original) The wafer edge exposing apparatus of claim1, wherein the wavelength converter is attachable/removable.
- (Original) The wafer edge exposing apparatus of claim 1, wherein an antireflective coating film (ARC) is coated on surface of the wavelength converter.
- 16. (Original) The wafer edge exposing apparatus of claim15, wherein the anti-reflective coating film (ARC) is made of one selected from the group consisting of zirconia (ZrO₂), magnesia (MgO), silica (SiO₂), titania (TiO₂), and combinations thereof.
- 17. (Previously presented) A wafer edge exposing apparatus, comprising: a light source device for generating a source light having a wavelength of about 315 nm to about 400 nm;

an optical fiber cord for guiding the source light;

a light focusing device for receiving the source light from the optical fiber cord and focusing the source light into a wafer; and

a wavelength converter which directly converts the wavelength of the source light to a wavelength of about 193 nm which corresponds to the highest absorptivity of a photoacid generator of resist coated on the wafer.

- 18. (Original) The wafer edge exposing apparatus of claim 17, wherein the wavelength converter is positioned in the light source device.
- 19. (Original) The wafer edge exposing apparatus of claim 18, wherein the wavelength converter is positioned in the light focusing device.
- 20. (Original) The wafer edge exposing apparatus of claim 17, wherein the light source device includes a lamp, a parabolic or elliptical mirror, a plate, a

shutter, and a filter.

- (Original) The wafer edge exposing apparatus of claim 17, wherein the wavelength converter is made of an optically non-linear material.
- 22. (Original) The wafer edge exposing apparatus of claim 21, wherein the optically non-linear material is one selected from the group consisting of beta barium borate (β-BaB₂O₄), lithium triborate (LiB₃O₅), cesium lithium borate (CsLiB₆O₁₀), potassium titanyl phosphate (KTiOPO₄), potassium titanyl arsenate (KTiOAsO₄), potassium dihydrogen phosphate (KH₂PO₄), deuterated ammonium dihydrogen phosphate (KD₂PO₄), ammonium dihydrogen phosphate (ND₄H₂PO₄), rubidium dihydrogen phosphate (RbH₂PO₄), cesium dihydrogen arsenate (CsH₂AsO₄), deuterated cesium dihydrogen arsenate (CsH₂AsO₄), lithium tantelate (LiTaO₃), lithium iodata (LiIO₃), potassium niobate (KNbO₃), barium nitrate (Ba(NO₃)₂), solid-state raman shifters (KGd(WO₄)₂), potassium pentaborate, 3-methyl-4-nitropyridine-1 oxide, L-ariginine phosphate, and combinations thereof.
- 23. (Original) The wafer edge exposing apparatus of claim 17, wherein the resist coated on the wafer is ArF resist.
- 24. (Original) The wafer edge exposing apparatus of claim 20, wherein the lamp is a mercury arc lamp.
- (Original) The wafer edge exposing apparatus of claim 17, wherein the source light is i-line.
- 26. (Original) The wafer edge exposing apparatus of claim 17, wherein the source light is one of lights having a wavelength within the ultraviolet range.

- (Original) The wafer edge exposing apparatus of claim 17, wherein the wavelength converter is made of either one of potassium titanyl phosphate (KTiOPO₄) and potassium dihydrogen phosphate (KH₂PO₄).
- 28. (Original) The wafer edge exposing apparatus of claim 17, wherein the wavelength converter is attachable/removable.
- (Original) The wafer edge exposing apparatus of claim 17, wherein an anti-reflective coating film (ARC) is coated on surface of the wavelength converter.
- 30. (Original) The wafer edge exposing apparatus of claim 29, wherein the anti-reflective coating film (ARC) is made of one selected from the group consisting of zirconia (ZrO₂), magnesia (MgO), silica (SiO₂), titania (TiO₂), and combinations thereof.
 - 31. (Previously presented) A wafer edge exposing apparatus, comprising: a light source device for generating source light;

an optical fiber cord for guiding the source light generated from the light source device into a light focusing device;

a lens positioned in the light focusing device to receive the source light from the optical fiber cord, the light focusing device to focus the source light to the edge of a wafer; and

a wavelength converter which directly converts a wavelength of the source light to a wavelength corresponding to the highest absorptivity of a photoacid generator of resist coated on the wafer.